

OCTAL DUAL SUPPLY BUS TRANSCEIVER

- **HIGH SPEED:**
 $t_{PD} = 8.5 \text{ ns (MAX.)}$ at
 $V_{CCA}=5.0V$ $V_{CCB} = 3.3V$
- **LOW POWER DISSIPATION:**
 $I_{CCA} = I_{CCB} = 5\mu A(\text{MAX.})$ at $T_A=25^\circ C$
- **LOW NOISE:** $V_{OLP} = 0.3V$ (TYP.) at
 $V_{CCA}=5.5V$ $V_{CCB}=3.3V$
- **SYMMETRICAL OUTPUT IMPEDANCE:**
 $|I_{OH}| = I_{OL} = 24mA$ (MIN)
- **BALANCED PROPAGATION DELAYS:**
 $t_{PLH} \cong t_{PHL}$
- **OPERATING VOLTAGE RANGE:**
 $V_{CCA}(\text{OPR}) = 4.5V \text{ to } 5.5V$ (1.2V Data Retention)
 $V_{CCB}(\text{OPR}) = 2.7V \text{ to } 3.6V$ (1.2V Data Retention)
 PIN AND FUNCTION COMPATIBLE WITH
 74 SERIES 4245
- **IMPROVED LATCH-UP IMMUNITY**

DESCRIPTION

The 74LVX4245 is a dual supply low voltage CMOS OCTAL BUS TRANSCEIVER fabricated with sub-micron silicon gate and double-layer metal wiring C^2MOS technology. Designed for use as an interface between a 5V bus and a 3.3V bus in a mixed 5V/3.3V supply systems, it achieves high speed operation while maintaining the CMOS low power dissipation.

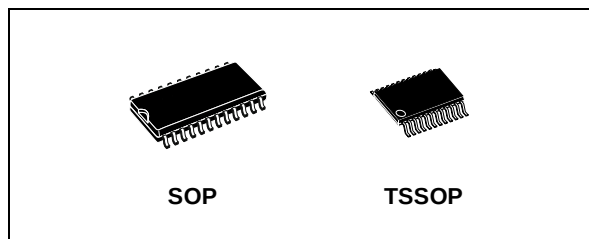


Table 1: Order Codes

PACKAGE	T & R
SOP	74LVX4245MTR
TSSOP	74LVX4245TTR

This IC is intended for two-way asynchronous communication between data buses and the direction of data transmission is determined by DIR input. The enable input $\bar{G}$ can be used to disable the device so that the buses are effectively isolated.

The A-port interfaces with the 5V bus, the B-port with the 3.3V bus.

All inputs are equipped with protection circuits against static discharge, giving them 2KV ESD immunity and transient excess voltage.

Figure 1: Pin Connection And IEC Logic Symbols

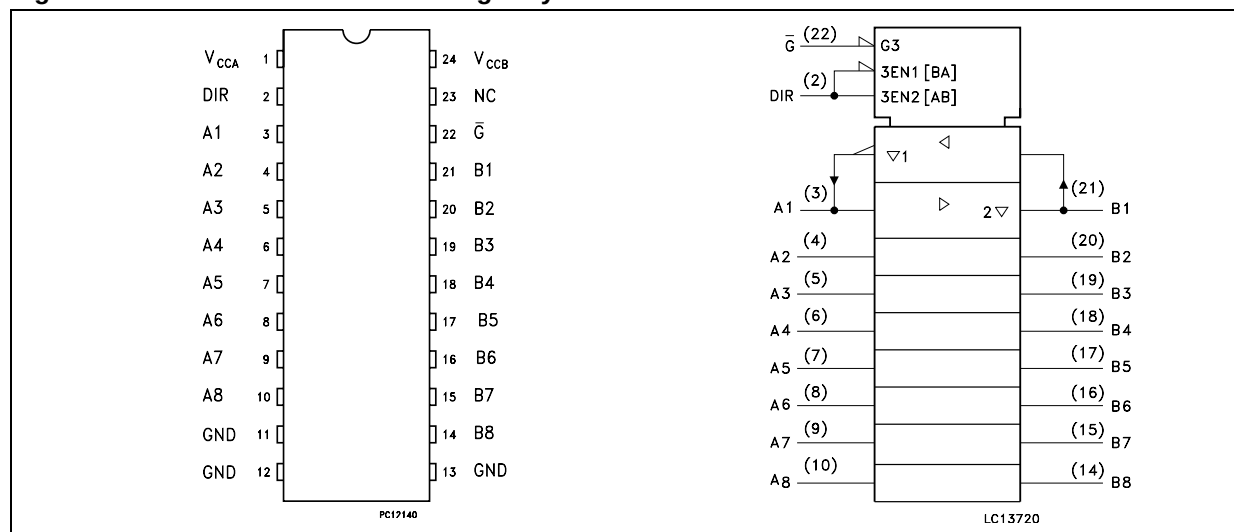


Figure 2: Input And Output Equivalent Circuit

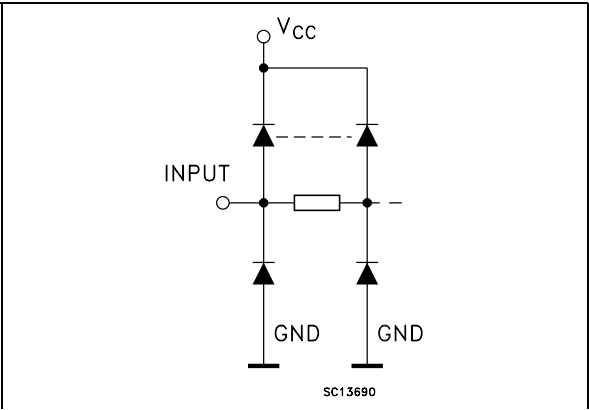


Table 2: Pin Description

PIN N°	SYMBOL	NAME QND FUNCTION
2	DIR	Directional Control
3, 4, 5, 6, 7, 8, 9, 10	A1 to A8	Data Inputs/Outputs
21, 20, 19, 18, 17, 16, 15, 14	B1 to B8	Data Inputs/Outputs
22	G	Output Enable Input
11, 12, 13	GND	Ground (0V)
23	NC	Not Connected
1	VCCA	Positive Supply Voltage
24	VCCB	Positive Supply Voltage

Table 3: Truth Table

INPUTS		FUNCTION		OUTPUT
$\overline{G}$	DIR	A BUS	B BUS	
L	L	OUTPUT	INPUT	A = B
L	H	INPUT	OUTPUT	B = A
H	X	Z	Z	Z

X : Don't Care
 Z : High Impedance

Table 4: Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V_{CCA}	Supply Voltage	-0.5 to +7.0	V
V_{CCB}	Supply Voltage	-0.5 to +7.0	V
V_I	DC Input Voltage	-0.5 to $V_{CCA} + 0.5$	V
$V_{I/OA}$	DC I/O Voltage	-0.5 to $V_{CCA} + 0.5$	V
$V_{I/OB}$	DC I/O Voltage	-0.5 to $V_{CCB} + 0.5$	V
I_{IK}	DC Input Diode Current	± 20	mA
I_{OK}	DC Output Diode Current	± 50	mA
I_{OA}	DC Output Current	± 50	mA
I_{OB}	DC Output Current	± 50	mA
I_{CCA}	DC V_{CC} or Ground Current	± 200	mA
I_{CCB}	DC V_{CC} or Ground Current	± 100	mA
P_d	Power Dissipation	180	mW
T_{stg}	Storage Temperature	-65 to +150	°C
T_L	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied

Table 5: Recommended Operating Conditions

Symbol	Parameter	Value	Unit
V_{CCA}	Supply Voltage (note 1)	4.5 to 5.5	V
V_{CCB}	Supply Voltage (note 1)	2.7 to 3.6	V
V_I	Input Voltage	0 to V_{CCA}	V
$V_{I/OA}$	I/O Voltage	0 to V_{CCA}	V
$V_{I/OB}$	I/O Voltage	0 to V_{CCB}	V
T_{op}	Operating Temperature	-55 to 125	°C
dt/dv	Input Rise and Fall Time (note 2)	0 to 10	ns/V

1) V_{IN} from 30% to 70% of V_{CC} 2) $V_{CCA} = 4.5$ to $5.5V$; $V_{CCB} = 2.7$ to $3.6V$;Table 6: DC Specifications For V_{CCA}

Symbol	Parameter	Test Condition			Value								Unit
		V _{CCA} (V)	V _{CCB} (V)		T _A = 25 °C			-40 to 85 °C		-55 to 125°C			
					Min.	Typ.	Max.	Min.	Max.	Min.	Max.		
V _{IHA}	High Level Input Voltage	4.5	3.3		2.0			2.0		2.0		V	
		5.5	3.3		2.0			2.0		2.0			
V _{ILA}	Low Level Input Voltage	4.5	3.3				0.8		0.8		0.8	V	
		5.5	3.3				0.8		0.8		0.8		
V _{OHA}	High Level Output Voltage	4.5	3.0	I _O =-100 μA	4.4	4.5		4.4		4.4		V	
		4.5	3.0	I _O =-24 mA	3.86			3.76		3.76			
V _{OLA}	Low Level Output Voltage	4.5	3.0	I _O =100 μA		0	0.1		0.1		0.1	V	
		4.5	3.0	I _O =24 mA			0.36		0.44		0.44		
I _{IA}	Input Leakage Current	5.5	3.6	V _I = V _{CC} or GND			± 0.1		± 1		± 1	μA	
I _{OZA}	High Impedance Output Leakage Current	5.5	3.6	V _{IA} = V _{IHA} or V _{ILA} V _{IB} = V _{IHB} or V _{ILB} V _{I/OA} = V _{CCA} or GND			± 0.5		± 5		± 5	μA	
I _{CCTA}	Quiescent Supply Current	5.5	3.6	V _{IA} = V _{CCA} or GND V _{IB} = V _{CCB} or GND			5		50		50	μA	
ΔI _{CCTA}	Maximum Quiescent Supply Current / Input (An, DIR, G)	5.5	3.6	V _{IA} = V _{CCA} - 2.1V V _{IB} = V _{CCB} or GND			1.35		1.5		1.5	mA	

Table 7: DC Specifications For V_{CCB}

Symbol	Parameter	Test Condition			Value								Unit
		V _{CCA} (V)	V _{CCB} (V)		T _A = 25 °C			-40 to 85 °C		-55 to 125°C			
					Min.	Typ.	Max.	Min.	Max.	Min.	Max.		
V _{IHB}	High Level Input Voltage	5.0	3.6		2.0			2.0		2.0		V	
		5.0	2.7		2.0			2.0		2.0			
V _{ILB}	Low Level Input Voltage	5.0	3.6				0.8		0.8		0.8	V	
		5.0	2.7				0.8		0.8		0.8		
V _{OHB}	High Level Output Voltage	4.5	3.0	I _O =-100 μA	2.9	3.0		2.9		2.9		V	
		4.5	3.0	I _O =-12 mA	2.48			2.4		2.4			
		4.5	2.7	I _O =-8 mA	2.26			2.2		2.2			
V _{OLB}	Low Level Output Voltage	4.5	3.0	I _O =100 μA		0.0	0.1		0.1		0.1	V	
		4.5	3.0	I _O =12 mA			0.31		0.40		0.40		
		4.5	2.7	I _O =8 mA			0.31		0.40		0.40		
I _{IB}	Input Leakage Current	5.5	3.6	V _I = V _{CCA} or GND			± 0.1		± 1		± 1	μA	
I _{OZB}	High Impedance Output Leakage Current	5.5	3.6	V _{IA} = V _{IHA} or V _{ILA} V _{I/OB} = V _{CCb} or GND			± 0.5		± 5		± 5	μA	
I _{CCIB}	Quiescent Supply Current	5.5	3.6	V _{IA} = V _{CCA} or GND V _{IB} = V _{CCB} or GND			5		50		5	μA	
ΔI _{CCIB}	Maximum Quiescent Supply Current / Input	5.5	3.6	V _{IA} = V _{CCA} or GND V _{IB} = V _{CCB} - 0.6V			0.35		0.5		0.35	mA	

Table 8: Dynamic Switching Characteristics

Symbol	Parameter	Test Condition			Value						Unit	
		V _{CCA} (V)	V _{CCB} (V)		T _A = 25 °C			-40 to 85 °C		-55 to 125°C		
					Min.	Typ.	Max.	Min.	Max.	Min.		Max.
V _{OLPA}	Dynamic Low Level Quiet Output (note 1, 2)	5.0	3.3			1.0	1.5					V
		5.0	3.3		-1.2	-0.6						
V _{OLPB}	Dynamic Low Level Quiet Output (note 1, 2)	5.0	3.3			0.8	1.2					V
		5.0	3.3		-0.8	-0.5						
V _{IHDA}	Dynamic High Voltage Input (note 1, 3)	5.0	3.3				2					V
V _{ILDA}	Dynamic Low Voltage Input (note 1, 3)	5.0	3.3		0.8							V
V _{IHDB}	Dynamic High Voltage Input (note 1, 3)	5.0	3.3				2					V
V _{ILDB}	Dynamic Low Voltage Input (note 1, 3)	5.0	3.3		0.8							V

1) Worst case package

2) Max number of output defined as (n). Data inputs are driven 0V to 3.3V, (n-1) outputs switching and one output at GND

3) Max number of data inputs (n) switching. (n-1) switching 0V to 3.3V. Inputs under test switching: 3V to threshold (V_{ILD}). 0V to threshold (V_{IHD}) $f = 1\text{ MHz}$

Table 9: AC Electrical Characteristics ($C_L = 50\text{pF}$, Input $t_r = t_f = 3\text{ns}$)

Symbol	Parameter	Test Condition		Value ⁽³⁾						Unit	
		V _{CCB} (V)		T _A = 25°C			-40 to 85°C		-55 to 125°C		
				Min.	Typ.	Max.	Min.	Max.	Min.		Max.
t _{PLH}	Propagation Delay Time (An to Bn)	2.7					1.0	10.0	1.0	11.0	ns
		3.0 ^(*)		1.0	5.1	8.5	1.0	9.0	1.0	10.0	
t _{PHL}	Propagation Delay Time (An to Bn)	2.7					1.0	10.0	1.0	11.0	
		3.0 ^(*)		1.0	5.3	8.5	1.0	9.0	1.0	10.0	
t _{PZL}	Output Enable Time ($\overline{G}$ to Bn)	2.7					1.0	11.5	1.0	12.5	ns
		3.0 ^(*)		1.0	6.5	10.0	1.0	10.5	1.0	11.5	
t _{PZH}	Output Enable Time ($\overline{G}$ to Bn)	2.7					1.0	11.5	1.0	11.5	
		3.0 ^(*)		1.0	6.7	10.0	1.0	10.5	1.0	11.5	
t _{PLZ}	Output Disable Time ($\overline{G}$ to Bn)	2.7					1.0	10.0	1.0	11.0	ns
		3.0 ^(*)		1.0	6.0	9.5	1.0	10.0	1.0	11.0	
t _{PHZ}	Output Disable Time ($\overline{G}$ to Bn)	2.7					1.0	7.5	1.0	8.5	
		3.0 ^(*)		1.0	3.3	6.5	1.0	7.0	1.0	8.0	
t _{PLH}	Propagation Delay Time (Bn to An)	2.7					1.0	10.0	1.0	11.0	ns
		3.0 ^(*)		1.0	5.4	8.5	1.0	9.0	1.0	10.0	
t _{PHL}	Propagation Delay Time (Bn to An)	2.7					1.0	10.0	1.0	11.0	
		3.0 ^(*)		1.0	5.5	8.5	1.0	9.0	1.0	10.0	
t _{PZL}	Output Enable Time ($\overline{G}$ to An)	2.7					1.0	10.0	1.0	11.0	ns
		3.0 ^(*)		1.0	5.2	9.0	1.0	9.5	1.0	10.5	
t _{PZH}	Output Enable Time ($\overline{G}$ to An)	2.7					1.0	10.0	1.0	11.0	
		3.0 ^(*)		1.0	5.8	9.0	1.0	9.5	1.0	10.5	
t _{PLZ}	Output Disable Time ($\overline{G}$ to An)	2.7					1.0	7.5	1.0	8.5	ns
		3.0 ^(*)		1.0	3.9	7.0	1.0	7.5	1.0	8.5	
t _{PHZ}	Output Disable Time ($\overline{G}$ to An)	2.7					1.0	7.5	1.0	8.5	
		3.0 ^(*)		1.0	2.9	6.5	1.0	7.0	1.0	8.0	
t _{OSLH} t _{OSHL}	Output To Output Skew Time (note1, 2)	2.7			0.5	1.0		1.5		1.5	ns
		3.3 ^(**)			0.5	1.0		1.5		1.5	

1) Skew is defined as the absolute value of the difference between the actual propagation delay for any two outputs of the same device switching in the same direction, either HIGH or LOW ($t_{OSLH} = |t_{PLHm} - t_{PLHn}|$, $t_{OSHL} = |t_{PHLm} - t_{PHLn}|$)

2) Parameter guaranteed by design

3) Typical values at $V_{CCA} = 5.0\text{V}$, $V_{CCB} = 3.3\text{V}$

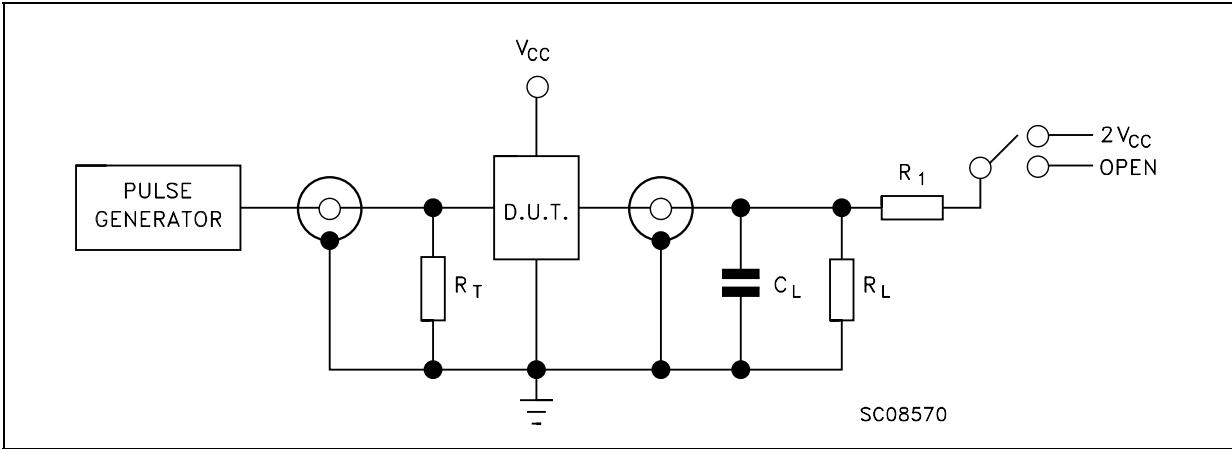
(*) Voltage range is $3.0\text{V} \pm 0.3\text{V}$

Table 10: Capacitive Characteristics

Symbol	Parameter	Test Condition			Value						Unit	
		V _{CCA} (V)	V _{CCB} (V)		T _A = 25 °C			-40 to 85 °C		-55 to 125°C		
					Min.	Typ.	Max.	Min.	Max.	Min.		Max.
C _{INA}	Input Capacitance	open	open			4.5	10		10		10	V
C _{I/O}	Input/Output Capacitance	3.3	5.0			10						V
C _{PD}	Dynamic Low Level Quiet Output (note 1) A to B	3.3	5.0			55						V
C _{PD}	Dynamic Low Level Quiet Output (note 1) B to A	3.3	5.0			40						V

1) C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average current can be obtained by the following equation. I_{CC(opr)} = C_{PD} × V_{CC} × f_{IN} + I_{CC}/8 (per circuit)

Figure 3: Test Circuit



TEST	SWITCH
t _{PLH} , t _{PHL}	Open
t _{PZLH} , t _{PLZ}	2V _{CC}
t _{PZH} , t _{PHZ}	Open

C_L = 50pF or equivalent (includes jig and probe capacitance)
R_L = R₁ = 500Ω or equivalent
R_T = Z_{OUT} of pulse generator (typically 50Ω)

Figure 4: Waveform - Propagation Delays ($f=1\text{MHz}$; 50% duty cycle)

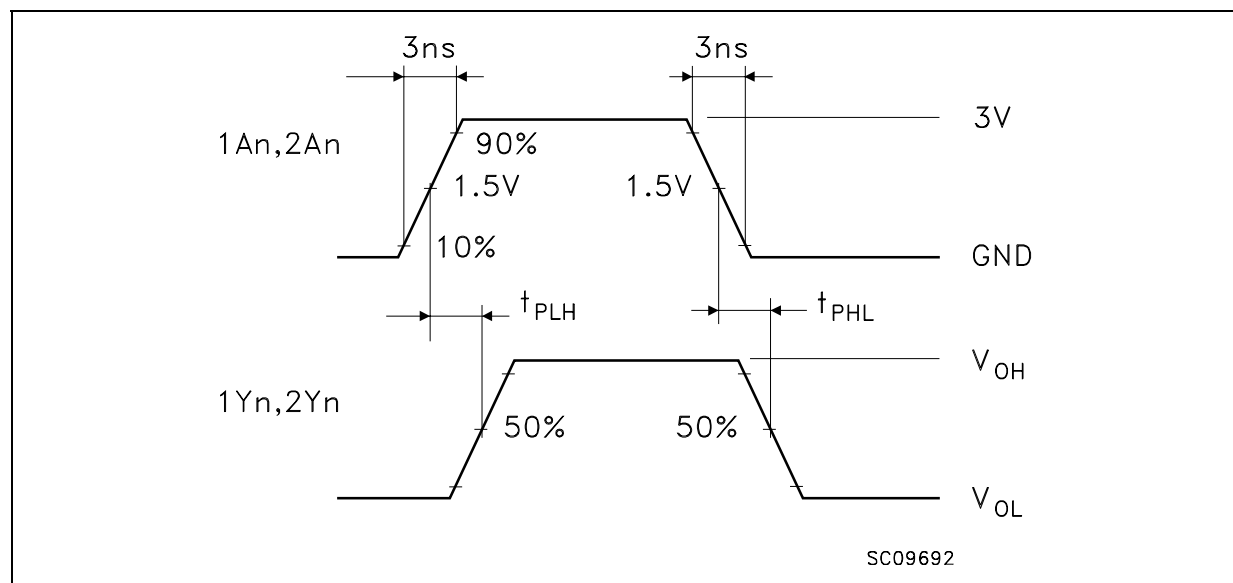
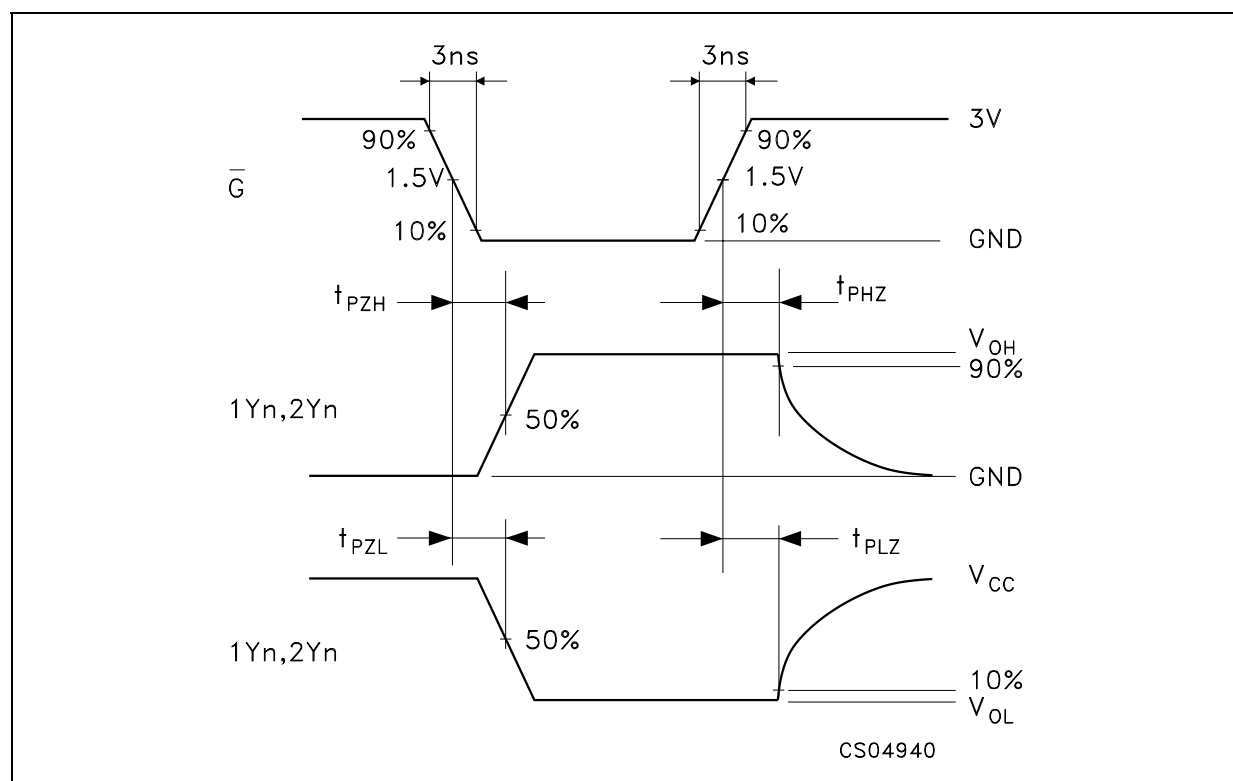
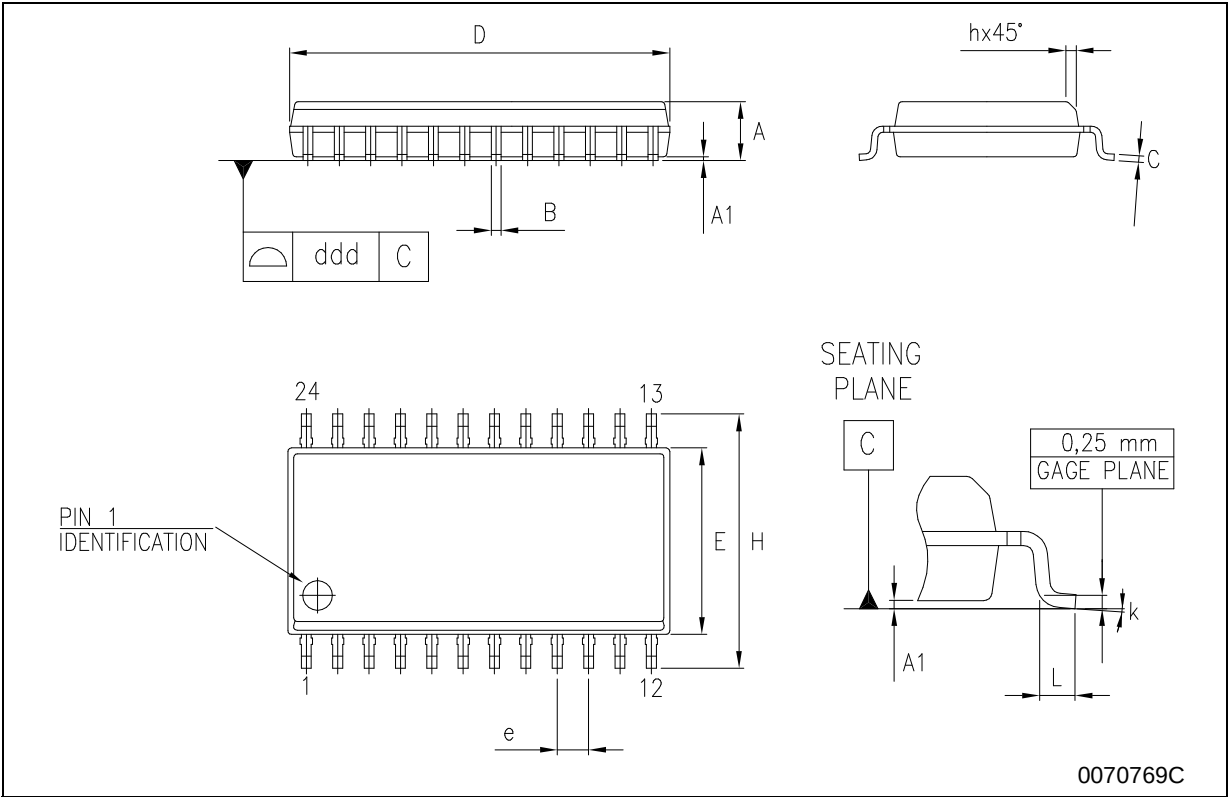


Figure 5: Waveform - Output Enable And Disable Time ($f=1\text{MHz}$; 50% duty cycle)



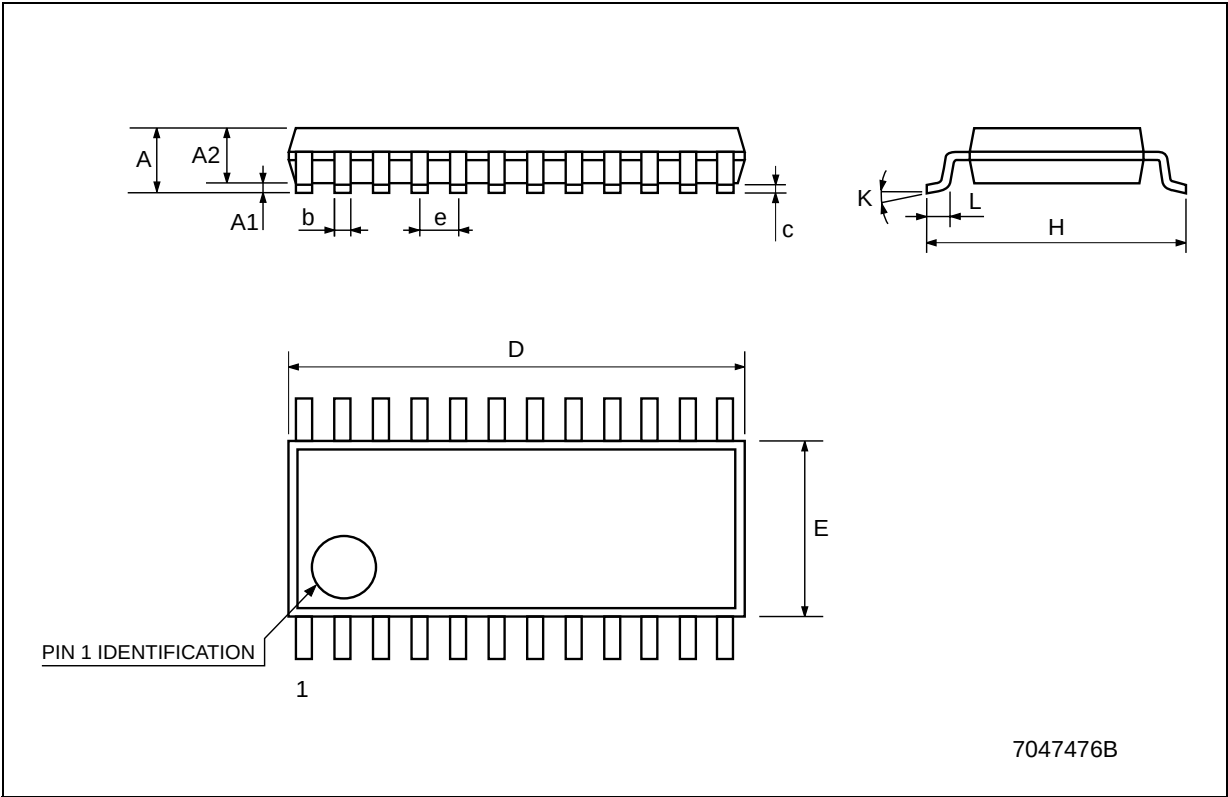
SO-24 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	2.35		2.65	0.093		0.104
A1	0.1		0.30	0.004		0.012
B	0.33		0.51	0.013		0.020
C	0.23		0.32	0.009		0.013
D	15.20		15.60	0.598		0.614
E	7.4		7.6	0.291		0.299
e		1.27			0.050	
H	10.00		10.65	0.394		0.419
h	0.25		0.75	0.010		0.030
L	0.4		1.27	0.016		0.050
k	0°		8°	0°		8°
ddd			0.100			0.004



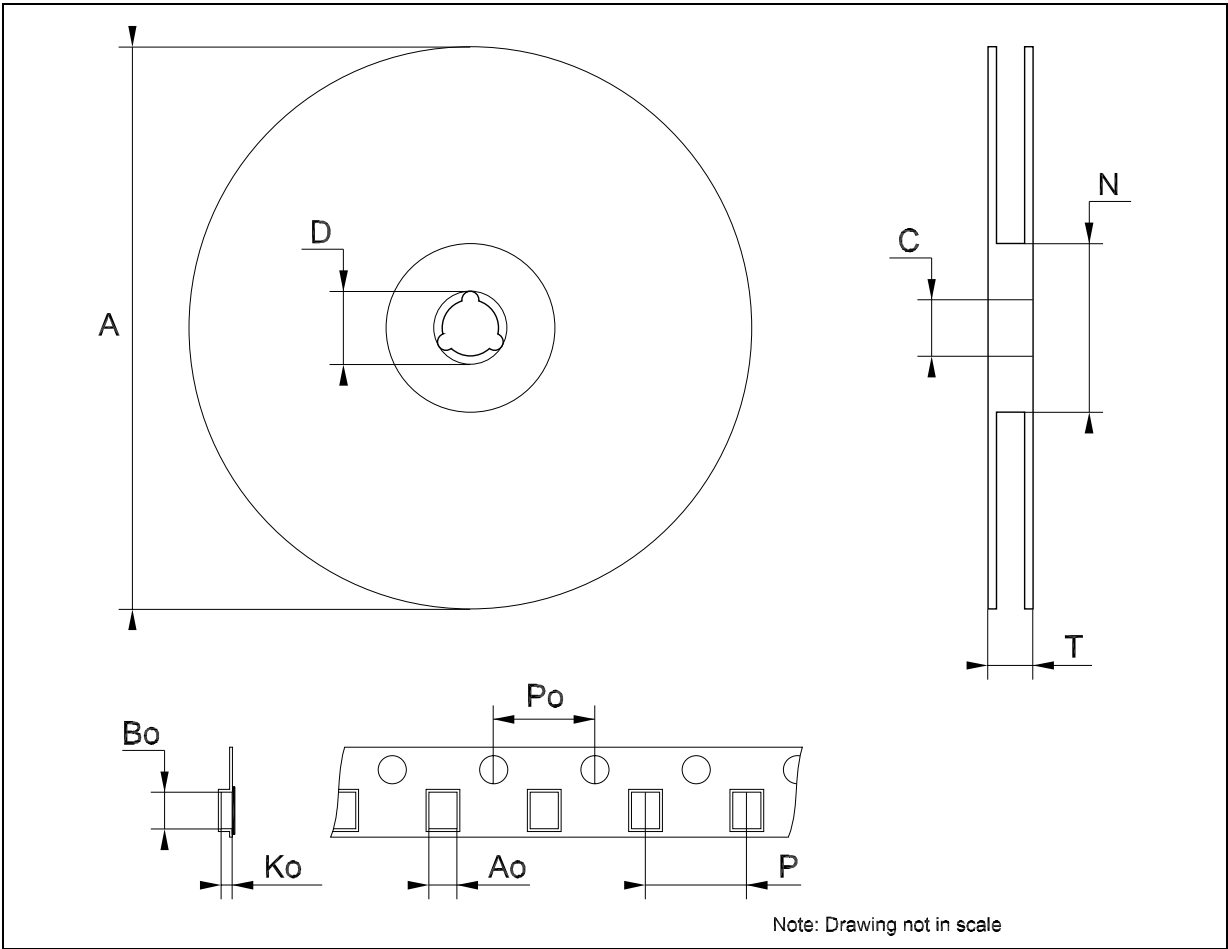
TSSOP24 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.1			0.043
A1	0.05		0.15	0.002		0.006
A2		0.9			0.035	
b	0.19		0.30	0.0075		0.0118
c	0.09		0.20	0.0035		0.0079
D	7.7		7.9	0.303		0.311
E	4.3		4.5	0.169		0.177
e		0.65 BSC			0.0256 BSC	
H	6.25		6.5	0.246		0.256
K	0°		8°	0°		8°
L	0.50		0.70	0.020		0.028



Tape & Reel SO-24 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			30.4			1.197
Ao	10.8		11.0	0.425		0.433
Bo	15.7		15.9	0.618		0.626
Ko	2.9		3.1	0.114		0.122
Po	3.9		4.1	0.153		0.161
P	11.9		12.1	0.468		0.476



Tape & Reel TSSOP24 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao	6.8		7	0.268		0.276
Bo	8.2		8.4	0.323		0.331
Ko	1.7		1.9	0.067		0.075
Po	3.9		4.1	0.153		0.161
P	11.9		12.1	0.468		0.476

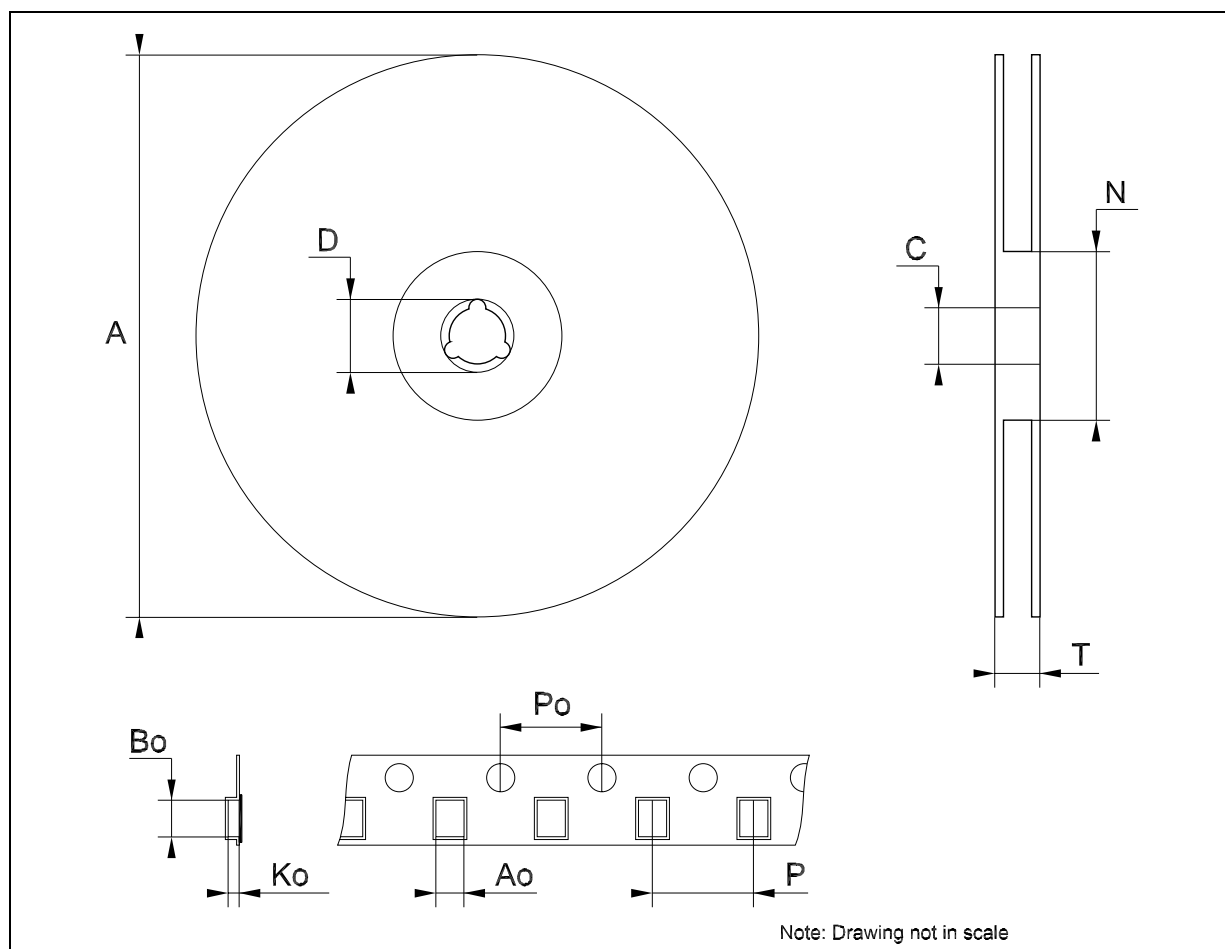


Table 11: Revision History

Date	Revision	Description of Changes
27-Aug-2004	6	Ordering Codes Revision - pag. 1.

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